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## FDS6575

### P-Channel 2.5V Specified PowerTrench<sup>®</sup> MOSFET

#### **General Description**

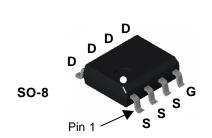
This PChannel 2.5V specified MOSFET is a rugged gate version of Fairchild Semiconductor's advanced PowerTrench process. It has been optimized for power management applications with a wide range of gate drive voltage (2.5V - 8V).

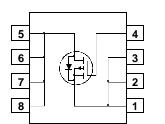
#### Applications

- Power management
- · Load switch
- Battery protection

#### Features

- -10 A, -20 V.  $R_{DS(ON)}$  = 13 m $\Omega$  @ V<sub>GS</sub> = -4.5 V  $R_{DS(ON)}$  = 17 m $\Omega$  @ V<sub>GS</sub> = -2.5 V
- Low gate charge
- High performance trench technology for extremely low  $R_{\text{DS}(\text{ON})}$
- High current and power handling capability





#### Absolute Maximum Ratings T<sub>A</sub>=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V <sub>DSS</sub>	Drain-Source Voltage		-20	V
V <sub>GSS</sub>	Gate-Source Voltage		±8	V
b	Drain Current – Continuous	(Note 1a)	-10	А
	– Pulsed		50	
PD	Power Dissipation for Single Operation	(Note 1a)	2.5	W
		(Note 1b)	1.5	
		(Note 1c)	1.2	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperate	ure Range	-55 to +175	°C
Therma	I Characteristics			
R <sub>0JA</sub>	Thermal Resistance, Junction-to-Ambient	(Note 1a)	50	°C/W
R <sub>0JA</sub>	Thermal Resistance, Junction-to-Ambient	(Note 1c)	125	°C/W
R <sub>0JC</sub>	Thermal Resistance, Junction-to-Case	(Note 1)	25	°C/W

#### **Package Marking and Ordering Information**

Device Marking	Device	Reel Size	Tape width	Quantity
FDS6575	FDS6575	13"	12mm	2500 units

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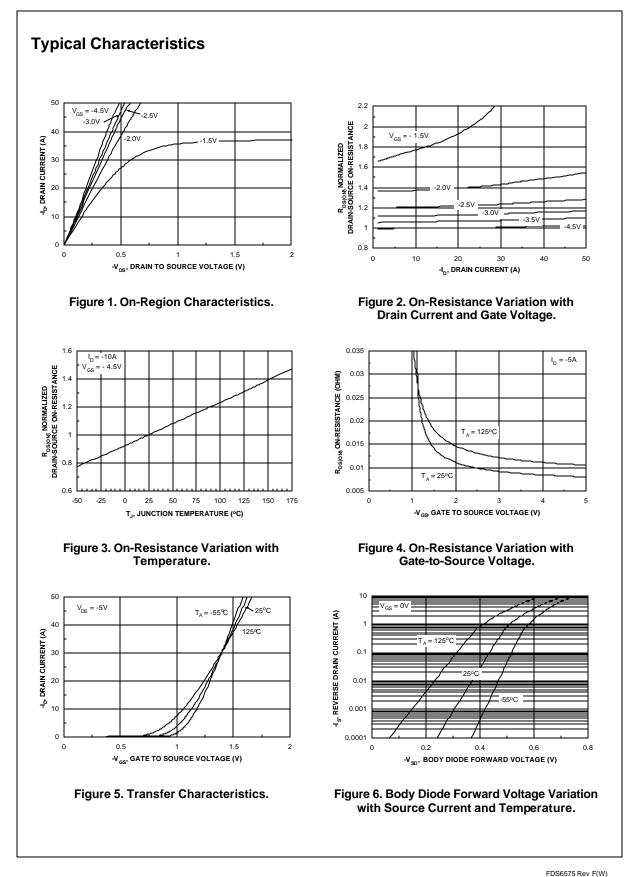
FDS6575

teristics rain–Source Breakdown Voltage reakdown Voltage Temperature pefficient ero Gate Voltage Drain Current	$V_{GS} = 0 \text{ V}, \text{ I}_D = -250 \mu\text{A}$ $\text{I}_D = -250 \mu\text{A}, \text{ Referenced to } 25^\circ\text{C}$	-20			V
rain–Source Breakdown Voltage reakdown Voltage Temperature pefficient		-20			V
pefficient	$I_D = -250 \ \mu\text{A}$ , Referenced to $25^{\circ}\text{C}$			-	
ro Gate Voltage Drain Current	1		-13		mV/°C
<b>U</b>	$V_{DS} = -16 V$ , $V_{GS} = 0 V$			-1	μA
ate–Body Leakage, Forward	$V_{GS} = 8 \text{ V}, \qquad V_{DS} = 0 \text{ V}$			100	nA
ate–Body Leakage, Reverse	$V_{GS} = -8 \text{ V}, \qquad V_{DS} = 0 \text{ V}$			-100	nA
eristics (Note 2)					
ate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	-0.4	-0.6	-1.5	V
ate Threshold Voltage emperature Coefficient	$I_D = -250 \ \mu\text{A}$ , Referenced to $25^{\circ}\text{C}$		3		mV/ºC
atic Drain–Source	$V_{GS} = -4.5 \text{ V},  I_D = -10 \text{ A}$		8.5	13	mΩ
1–Resistance	66 , B				
- Ctata Drain Current		50	11	20	٨
		-50	57		A S
	V DS = -5 V, ID = -10 A		57		3
			4051		pF
					pr pF
					pr pF
•			101		P
	$V_{pp} = -10V$ $h_{p} = -1.4$		16	29	ns
,	$V_{GS} = -4.5 \text{ V},  R_{GEN} = 6 \Omega$		-	-	ns
	•		-	-	ns
urn–Off Fall Time	•			-	ns
	$V_{DS} = -10 V$ . $I_D = -10 A$ .		53	74	nC
0	$V_{GS} = -4.5 V$		6		nC
ate–Drain Charge			12		nC
rce Diode Characteristics	and Maximum Ratings	L	I	l	I.
				-2.1	Α
rain–Source Diode Forward Ditage	$V_{GS} = 0 \ V, \ I_S = -2.1 \ A$ (Note 2)		-0.6	-1.2	V
	ate Threshold Voltage ate Threshold Voltage emperature Coefficient atic Drain–Source n–Resistance n–State Drain Current orward Transconductance haracteristics out Capacitance utput Capacitance everse Transfer Capacitance <b>Characteristics</b> (Note 2) Irn–On Delay Time Irn–On Rise Time Irn–Off Delay Time Irn–Off Fall Time otal Gate Charge ate–Source Charge ate–Source Charge ate–Drain Charge <b>Ce Diode Characteristics</b> aximum Continuous Drain–Source ain–Source Diode Forward obtage	ate Threshold Voltage $V_{DS} = V_{GS}$ , $b = -250 \ \mu A$ ate Threshold Voltage $b = -250 \ \mu A$ , Referenced to 25°CImperature Coefficient $b = -250 \ \mu A$ , Referenced to 25°Catic Drain–Source $V_{GS} = -4.5 \ V$ , $b = -10 \ A$ $v_{GS} = -4.5 \ V$ , $b = -10 \ A$ $V_{GS} = -4.5 \ V$ , $b = -9 \ A$ $v_{GS} = -4.5 \ V$ , $b = -10 \ A$ , $T_J = 125°C$ $n$ -Resistance $V_{GS} = -4.5 \ V$ , $V_{DS} = -5 \ V$ $n$ -State Drain Current $V_{GS} = -4.5 \ V$ , $V_{DS} = -5 \ V$ $v_{GS} = -4.5 \ V$ , $b = -10 \ A$ $haracteristics$ $put Capacitance$ $V_{DS} = -10 \ V$ , $V_{GS} = 0 \ V$ , $f = 1.0 \ MHz$ $rm-On Delay Time$ $V_{DD} = -10V$ , $b = -1 \ A$ , $V_{GS} = -4.5 \ V$ , $R_{GEN} = 6 \ \Omega$ $rm-Off Delay Time$ $V_{DS} = -10 \ V$ , $b = -10 \ A$ , $V_{GS} = -4.5 \ V$ $rm-Off Fall Time$ $V_{DS} = -10 \ V$ , $b = -10 \ A$ , $V_{GS} = -4.5 \ V$ $rm-Off Fall Time$ $V_{DS} = -10 \ V$ , $b = -10 \ A$ , $V_{GS} = -4.5 \ V$ $rm-Off Fall Time$ $V_{DS} = -10 \ V$ , $b = -10 \ A$ , $V_{GS} = -4.5 \ V$ $rm-Off Fall Time$ $V_{DS} = -10 \ V$ , $b = -10 \ A$ , $V_{GS} = -4.5 \ V$ $re Diode Characteristics and Maximum Ratings$ aximum Continuous Drain–Source Diode Forward Current ain–Source Diode Forward oltage $v_{GS} = 0 \ V$ , $v_S = -2.1 \ A$ (Note 2) $re purclion-to-case and case-to-ambient thermal resistance where the case thermal reference is define$	ate Threshold Voltage $V_{DS} = V_{GS}$ , $b = -250 \ \mu\text{A}$ $-0.4$ ate Threshold Voltage $b = -250 \ \mu\text{A}$ , Referenced to $25^{\circ}\text{C}$ atte Threshold Voltage $b = -250 \ \mu\text{A}$ , Referenced to $25^{\circ}\text{C}$ atte Drain–Source $V_{GS} = -4.5 \ V$ , $b = -10 \ A$ $n$ -Resistance $V_{GS} = -4.5 \ V$ , $b = -9 \ A$ $V_{GS} = -4.5 \ V$ , $b = -9 \ A$ $V_{GS} = -4.5 \ V$ , $b = -9 \ A$ $V_{GS} = -4.5 \ V$ , $b = -10 \ A$ , $T_J = 125^{\circ}\text{C}$ $-50$ $n$ -State Drain Current $V_{GS} = -4.5 \ V$ , $V_{DS} = -5 \ V$ $-50$ $n$ -state Drain Current $V_{GS} = -4.5 \ V$ , $b = -10 \ A$ $-10 \ A$ <b>haracteristics</b> $V_{DS} = -10 \ V$ , $V_{GS} = 0 \ V$ , $f = 1.0 \ MHz$ $V_{DS} = -10 \ A$ $h$ -acteristics (Note 2) $V_{DD} = -10 \ V$ , $V_{GS} = 0 \ V$ , $f = 1.0 \ MHz$ $V_{DS} = -10 \ V$ , $V_{GS} = 0 \ V$ , $V_{GS} = -4.5 \ V$ , $R_{GEN} = 6 \ \Omega$ $rm-On Delay TimeV_{DS} = -10 \ V, V_{CS} = -4.5 \ Vb = -10 \ A, V_{GS} = -4.5 \ Vrm-Off Delay TimeV_{DS} = -10 \ V, b = -10 \ A, V_{GS} = -4.5 \ Vb = -10 \ A, V_{GS} = -4.5 \ Vrm-Off Fall TimeV_{DS} = -10 \ V, b = -10 \ A, V_{GS} = -4.5 \ Vb = -10 \ A, V_{GS} = -4.5 \ Vre-Source ChargeV_{DS} = -10 \ V, b = -10 \ A, V_{GS} = -4.5 \ Vb = -10 \ A, V_{GS} = -4.5 \ Vre-Drain ChargeV_{DS} = -10 \ V, b = -10 \ A, V_{GS} = -4.5 \ Vb = -10 \ A, V_{GS} = -4.5 \ Vre-Drain ChargeV_{DS} = -10 \ V, b = -10 \ A, V_{GS} = 0 \ V, b = -2.1 \ A (Note 2)re-Drain Continuous Drain–Source Diode Forward Currenta = 0 \ V, b$	ate Threshold Voltage ate Threshold Voltage amperature Coefficient $V_{DS} = V_{GS}, b = -250 \ \mu\text{A}$ $-0.4$ $-0.6$ ate Threshold Voltage amperature Coefficient $b = -250 \ \mu\text{A}$ , Referenced to $25^{\circ}\text{C}$ 3atic Drain–Source n–Resistance $V_{GS} = -4.5 \ V, b = -10 \ A$ 8.5n–Resistance $V_{GS} = -4.5 \ V, b = -9 \ A$ 11n–State Drain Current $V_{GS} = -4.5 \ V, b = -10 \ A$ 57haracteristics $V_{DS} = -5 \ V, b = -10 \ A$ 57but Capacitance $V_{DS} = -5 \ V, b = -10 \ A$ 57haracteristics $V_{DS} = -10 \ V, \ V_{GS} = 0 \ V, f = 1.0 \ MHz$ 884everse Transfer Capacitance $V_{DS} = -10 \ V, \ V_{GS} = 0 \ V, f = 1.0 \ MHz$ 16urn–On Delay Time $V_{DS} = -10 \ V, \ V_{GS} = -4.5 \ V, \ R_{GEN} = 6 \ \Omega$ 9urn–Off Delay Time $V_{DS} = -10 \ V, \ V_{DS} = -10 \ A, \ V_{GS} = -4.5 \ V$ 6ate–Drain Charge $V_{DS} = -10 \ V, \ V_{DS} = -10 \ A, \ V_{GS} = -4.5 \ V$ 6ate–Drain Charge $V_{DS} = -10 \ V, \ V_{DS} = -10 \ A, \ V_{GS} = -4.5 \ V$ 12ce Diode Characteristics and Maximum Ratings12aximum Continuous Drain–Source Diode Forward Current12ain–Source Diode Forward $V_{GS} = 0 \ V, \ V_{S} = -2.1 \ A \ (Note 2)$ -0.6	tate Threshold Voltage ate Threshold Voltage mperature Coefficient $V_{DS} = V_{GS}, b = -250 \ \mu A$ $-0.4$ $-0.6$ $-1.5$ ate Threshold Voltage mperature Coefficient $b = -250 \ \mu A$ , Referenced to $25^{\circ}C$ 33atic Drain–Source h-Resistance $V_{GS} = -4.5 \ V, \ b = -10 \ A$ $8.5 \ 13$ $v_{GS} = -2.5 \ V, \ b = -9 \ A$ 1117 $V_{GS} = -4.5 \ V, \ b = -9 \ A$ 1120 $n$ -State Drain Current $V_{GS} = -4.5 \ V, \ b = -10 \ A$ $57$ $n$ -State Drain Current $V_{GS} = -4.5 \ V, \ b = -10 \ A$ $57$ $b$ mward Transconductance $V_{DS} = -5 \ V, \ b = -10 \ A$ $57$ $b$ macteristics $V_{DS} = -10 \ V, \ V_{GS} = 0 \ V, \ f = 1.0 \ MHz$ $884$ $averse Transfer CapacitanceV_{DS} = -10 \ V, \ V_{GS} = 0 \ V, \ f = 1.0 \ MHz884averse Transfer CapacitanceV_{DS} = -10 \ V, \ V_{GS} = -10 \ A, \ V_{GS} = -4.5 \ V, \ R_{GEN} = 6 \ \Omega918m-On Delay TimeV_{DS} = -10 \ V, \ b = -10 \ A, \ V_{GS} = -4.5 \ V, \ R_{GEN} = 6 \ \Omega918m-Off Delay TimeV_{DS} = -10 \ V, \ b = -10 \ A, \ V_{GS} = -4.5 \ V6tal Gate ChargeV_{DS} = -10 \ V, \ b = -10 \ A, \ V_{GS} = -4.5 \ V6tal Gate ChargeV_{DS} = -10 \ V, \ b = -10 \ A, \ V_{GS} = -4.5 \ V6tal Gate ChargeV_{CS} = 0 \ V, \ b = -10 \ A, \ V_{GS} = -4.5 \ V6tal Gate ChargeV_{CS} = 0 \ V, \ b = -2.1 \ A \ (Note 2)-0.6 \ -1.2tal Gate ChargeV_{CS} = 0 \ V, \ b = -2.1 \ A \ (Note 2)-0.6 \ -1.2$

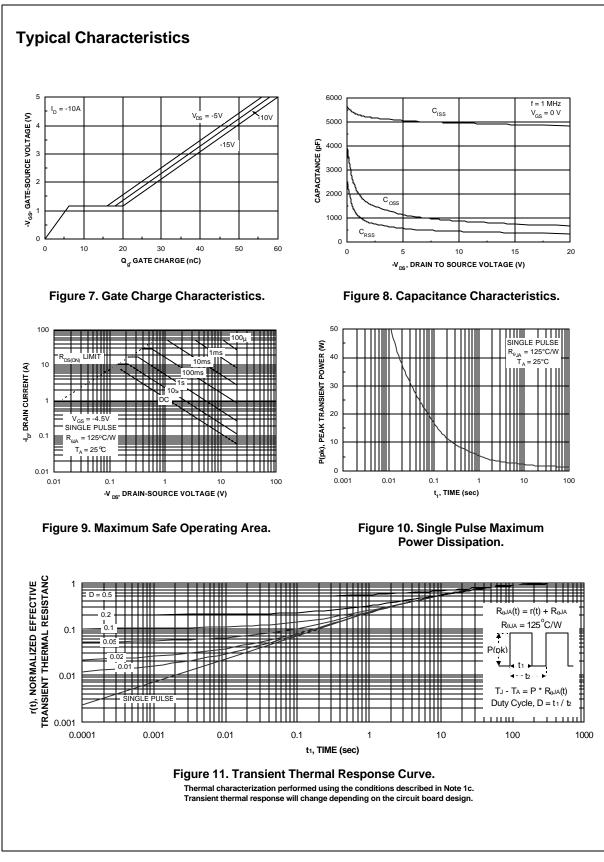
Scale 1 : 1 on letter size paper

2. Pulse Test: Pulse Width < 300 $\mu$ s, Duty Cycle < 2.0%

FDS6575 Rev F(W)



FDS6575



FDS6575 Rev F(W)

# FDS6575

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